



Appl. No. : 10/036,796
Applicant : Driscoll et al.
Filed : 01/07/2002

Confirmation No.: 4854

Title : High-Speed, High Density Interconnect System ...

TC/A.U. : 2833
Examiner : Xuong M. Chung Trans

Docket : 2885-118 (formerly 3395-089)
Cust. No. : 6449

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Date: March 12, 2004

REPLY TO OFFICE ACTION

Dear Sir:

This Reply is in response to the Office Action mailed on
December 4, 2003.

Amendments to the claims are reflected in the listing of
claims which begins on page 2 of this paper.

Remarks begin on page 13 of this paper.

04/02/2004 SMINASS1 00000032 10036796

01 FC:1251

110.00 OP